

# PATENT ABSTRACTS OF JAPAN

(11)Publication number : **02-027748**

(43)Date of publication of application : **30.01.1990**

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(51)Int.Cl.

**H01L 21/68**

**B23Q 3/15**

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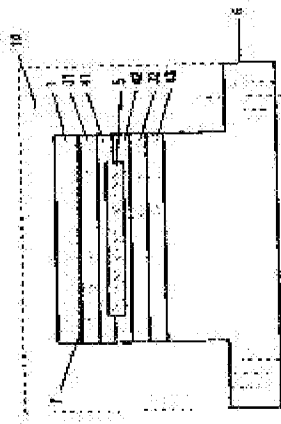
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(54) **ELECTROSTATIC CHUCKING DEVICE AND FORMING METHOD THEREFOR**

(57)Abstract:

PURPOSE: To reduce the thickness of the whole sheet and to enhance adhesive properties by forming an electrostatic chucking sheet of a laminate made of a first insulating layer, a first adhesive layer, an electrode layer, a second adhesive layer and a second insulating layer.

CONSTITUTION: An electrostatic chucking sheet adheres to a metal board 6 through an adhesive layer 43. The sheet is of a laminate sequentially formed of a first insulating layer 31 having a face for placing an article to be attracted, a first adhesive layer 41, an electrode layer 5 for generating polarized charge on the face for placing the article to be attracted of the layer 31, a second adhesive layer 42, and a second insulating layer 32 with 30-40 $\mu$ m. Thermal conductive filler is dispersed in one or more of the layers



43, 41, 42. Thus, the thickness of the whole sheet is reduced to enhance its adhesive properties.